



Cus	Customer: C1A001151							
Part No: <u>CL-SFZ515DBW-7.5K-01</u>								
Samp	ole No :							
Descr	Description: 5054 White SMD							
Item No:								
	Cust	omer						
		T						
Check	Inspection	Date						
CL								
Drawn	Inspection	Approval	Date					
			2023/8/8					



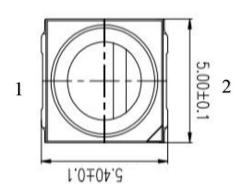


Features:

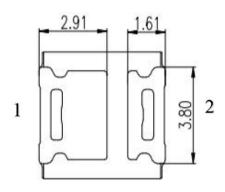
- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

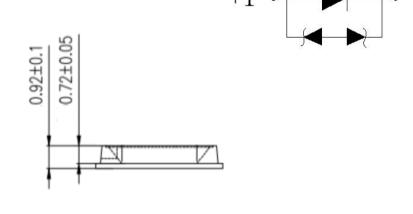
Applications

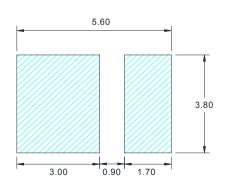
- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use











Notes:

- 1 . All dimension units are millimeters.
- 2. All dimension tolerance is ± 0.1 mm unless otherwise noted.

REV NO: A/1 Page :1 of 10





Selection Guide

	Emitting LT.		Lumino	us Flux(LM) @) 150mA	Viewing Angle
Part No.	Color	Lens Type	Min	Тур	Max	201/2
CL-SFZ515DBW-7.5K-01	White	Yellow Diffused	55		70	120

Note:

- 1.201/2 is the angle from optical centerline where the luminous intensity is 201/2 the optical centerline value.
- 2. The above luminous intensity measurement allowance tolerance $\pm 10\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.8		3.5	V	IF=150mA
Reverse Current	IR	-		10	uA	VR = 5V
Color Rndering Index	Ra	75			/	IF=150mA
Color Temperature	TC	7000		8000	K	II 150IIIA

Note:

- 1. The above forward voltagemeasurement allowance tolerance $\pm 0.1 V$.
- 2. Measurement Uncertainty of the Color Coordinates : ± 0.003
- 3. Ra measurement tolerance is ± 1
- 4. Measurement error of color temperature ± 150 K

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	525	mW
DC Forward Current	IF	150	mA
Peak Forward Current [1]	IFP	300	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

Note:

1. 1/10 Dut cycle,0.1ms pulse width.

REV NO: A/1 Page :2 of 10





BIN CODE LIST

Luminous Intensity(IV)							
BIN CODE MIN MAX Unit IF							
55	55	60					
60	60	65	LM	150mA			
65	65	70					

Tolerance on each Intensity bin is:+/-10%

Forward Voltange(VF)							
BIN CODE MIN MAX Unit IF							
VD1	2.8	2.9					
VD2	2.9	3.0					
VD3	3.0	3.1					
VD4	3.1	3.2	V	150mA			
VE1	3.2	3.3					
VE2	3.3	3.4					
VE3	3.4	3.5					

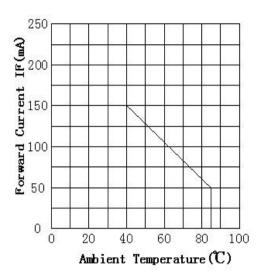
Tolerance on each Forward Voltage bin is:+/-0.1V

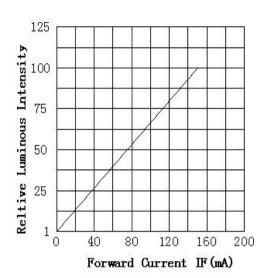
REV NO: A/1 Page :3 of 10

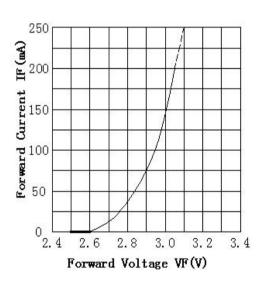


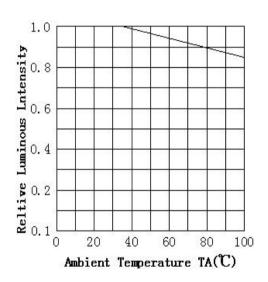


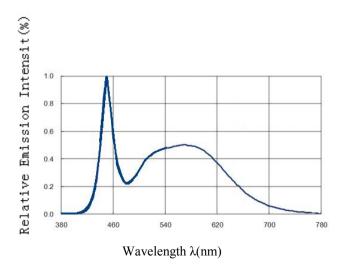
Typical optical characteristics curves

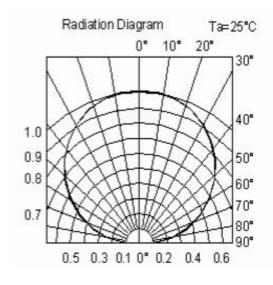










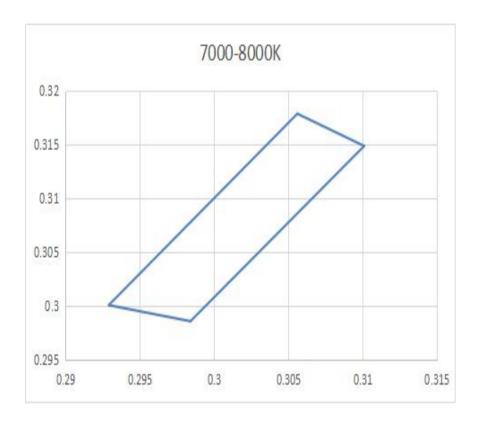


REV NO: A/1 Page :4 of 10





Bin Color



CCT	7000-8000K			
BIN	Х	Y		
	0.3056	0. 3179		
	0. 2929	0. 3001		
70K	0. 2984	0. 2986		
	0.3101	0. 3149		
	0. 3056	0. 3179		

Notes:Measurement Uncertainty of the Color Coordinates : ± 0.01 .

A/1 Page :5 of 10





Reliability Test Items And Conditions

Test Items	Ref.Standard	Test conditions	Time	Quantity	Ac/Re
Reflow Soldering	JESD22-B106	Temp.:260°C±5°C Min.5sec.	3 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	100°C±5°C 30 min. ↑↓5 min -40°C±5°C 30 min.	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100°C±5°C	1000Hrs	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40°C±5°C	1000Hrs	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25°C±5°C IF=150mA	1000Hrs	22Pcs.	0/1
High temperature and high humidity storage experiment	JESD22-A101	85°C±5°C/ 85%RH	1000Hrs	22Pcs.	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement	
			Min.	Max.
Forward Voltage	VF	IF=150mA		U.S.L*)x1.1
Reverse Current	IR	VR = 5V		U.S.L*)x2.0
Luminous intensity	IV	IF=150mA	L.S.L*)x0.7	

U.S.L: Upper standard level

L.S.L: Lower standard level

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

REV NO: A/1 Page :6 of 10

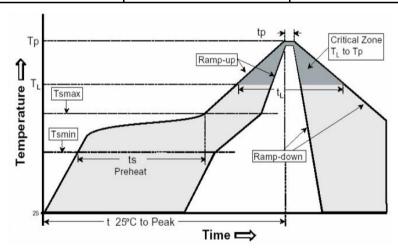




SMT Reflow Soldering Instructions

- 1. The number of reflow soldering shall not exceed two times,and the time from the second processing to the first completion shall not exceed 24H
- 2. When soldering, do not put stress on the LEDs during heating.
- 3.Reflow temperature distribution (Acc.to J-STD-020D)

D., 61. F. 4	Sn-Pb Eutec	tic Assembly	Pb-Free Assembly		
Profile Feature	Large Body	Small Body	Large Body	Small Body	
Average ramp-up rate (TL to Tp)	3 ℃/second max.		3°C/second max.		
Preheat -Temperature Min(TSmin) -Temperature Max(TSmax) -Time(min to max)(ts)	150	100° C 150° C 150° C 200° C $60\text{-}120$ seconds $60\text{-}180$ seconds		${\mathbb C}$	
Tsmax to TL -Ramp-up Rate			3℃/seco	ond max.	
Time maintained above: -Temperature(TL) -Time(tL)	183 °C 60-150 seconds		217°C 60-150 seconds		
Peak Temperature(Tp)	225+0/-5°C	240+0/-5°C	245+0/-5°C	260+0/-5℃	
Time within 5°C of actual Peak Temperature(tp)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds	
Ramp-down Rate	6°C/second max.		6°C/second max.		
Time 25°C to Peak Temperat	nt 6 minutes max. 8 minutes max		es max.		

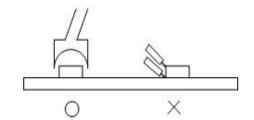


Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 350°C for 3 seconds
- 2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used(as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



REV NO: A/1 Page :7 of 10





Storage

This product uses sealing anti-moisture antistatic packaging, and with desiccant, humidity card.

Before packaging is opened:

- 1. The storage environment is: the ambient temperature should be maintained between 5 ° C and 30 ° C, and the relative humidity should be kept within 60% RH. (The storage period is 2 months. If more than two months, please return the product to our company to help dehumidify)
 - 2. Please check the package for leaks before opening. If there is a leak, return to the factory for dehumidification.

After opening the package:

- 1. After opening the package, check whether the humidity card has a discoloration phenomenon. Please remove the material from the bag and use it after dehumidifying 24H at 65 °C.
- 2. Environmental conditions: The ambient temperature should be kept between \leq 30 ° C and relative humidity The lower 60 % RH should be maintained.
- 3. if the material is not produced after exposure in the workshop for more than 24 hours, the product must be put back in the oven, dehumidified with 65 °C 24H, and then can be used again. If the material is not produced after 48 hours of exposure in the workshop, return the material to the SMD plant for high temperature dehumidification.
- 4. When the material is dehumidified, please do not open the oven in the middle, so that the oven temperature will not drop to the dehumidification effect.

Please refer to the following operating methods when the material needs to be dehumidified



Correct way: material desiccant need to remove the bag, use the way of hanging baked

正确的方法: 材料需要去掉袋子, 使用挂烤的方式烘烤。





Wrong way: the material is dehumidified without removing the bag, in a stacking manner

错误的做法是: 以堆叠方式或材料不取出袋子烘烤。

REV NO: A/1 Page :8 of 10





ESD

Static Electrisity will damage the LED.

The following steps can reduce the likelihood of ESD causing product damage

- 1. All productive machinery and test instruments must be electrically grounded.
- 2. Use a condustive wrist band or anti-electostatic glove when handling these LEDs.
- 3. Manintain a humidity level of 50%RHor higher in production areas.
- 4. Use anti-static packaging for transport and storage.

Handling Precautions

1. Do not stack the assembled PCB together. This may scratch the surface of the product or damage the circuit.



2. Not available in the situation of acidity for PH.



3. Electrostatic sensitive device



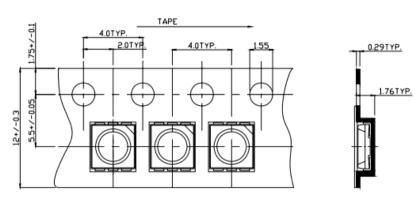
REV NO: A/1 Page :9 of 10



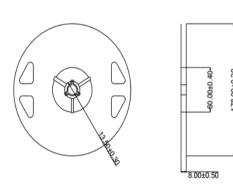


CL-SFZ515DBW-7.5K-01

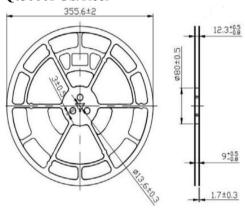
Carrier tape



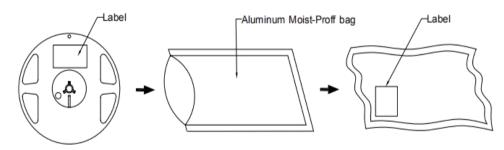
MPQ:1000PCS/Reel



SPQ:5000PCS/Reel

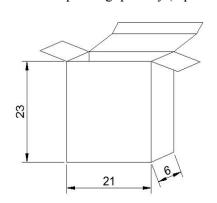


Moisture Resistant Packaging

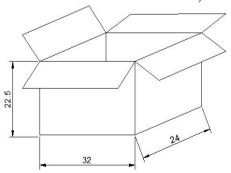


Cardboard Box

Maximum packing quantity (5 packs of material)



Maximum packing quantity (27 bags of material or 5 small boxes)



Page :10 of 10